



Material Content Data Sheet



Sales Product Name		IPG20N06S2L-35A		Issued		20. July 2018		
MA#		MA001668914						
Package		PG-TDSON-8-10		Weight*		99.70 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	3.173	3.18	3.18	31827	31827
leadframe	inorganic material	phosphorus	7723-14-0	0.014	0.01		140	
	non noble metal	iron	7439-89-6	0.046	0.05		466	
	non noble metal	copper	7440-50-8	46.380	46.52	46.58	465180	465786
	non noble metal	aluminium	7429-90-5	0.755	0.76	0.76	7569	7569
wire	non noble metal	aluminium	7429-90-5	0.755	0.76	0.76	7569	7569
encapsulation	organic material	carbon black	1333-86-4	0.088	0.09		880	
	plastics	epoxy resin	-	6.228	6.25		62461	
	inorganic material	silicondioxide	60676-86-0	37.541	37.65	43.99	376524	439865
leadfinish	non noble metal	tin	7440-31-5	1.396	1.40	1.40	14006	14006
plating	inorganic material	phosphorus	7723-14-0	0.001	0.00		14	
	non noble metal	nickel	7440-02-0	0.603	0.60	0.60	6049	6063
solder	non noble metal	tin	7440-31-5	0.070	0.07		698	
	noble metal	silver	7440-22-4	0.087	0.09		872	
	non noble metal	lead	7439-92-1	3.322	3.33	3.49	33314	34884
*deviation	< 10%				Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com